

# PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT												
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT												
<b>CONVEYING PARTY DATA</b>													
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Anthony Yeh Chiing Wong</td> <td>06/08/2007</td> </tr> <tr> <td>Victor Henckel</td> <td>06/14/2007</td> </tr> <tr> <td>Boon Liang Heng</td> <td>06/08/2007</td> </tr> <tr> <td>Christopher Wade Ackerman</td> <td>06/07/2007</td> </tr> <tr> <td>James C. Shipley</td> <td>06/07/2007</td> </tr> </tbody> </table>		Name	Execution Date	Anthony Yeh Chiing Wong	06/08/2007	Victor Henckel	06/14/2007	Boon Liang Heng	06/08/2007	Christopher Wade Ackerman	06/07/2007	James C. Shipley	06/07/2007
Name	Execution Date												
Anthony Yeh Chiing Wong	06/08/2007												
Victor Henckel	06/14/2007												
Boon Liang Heng	06/08/2007												
Christopher Wade Ackerman	06/07/2007												
James C. Shipley	06/07/2007												
<b>RECEIVING PARTY DATA</b>													
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;"><b>Name:</b></td> <td>Intel Corporation</td> </tr> <tr> <td><b>Street Address:</b></td> <td>2200 Mission College Boulevard</td> </tr> <tr> <td><b>City:</b></td> <td>Santa Clara</td> </tr> <tr> <td><b>State/Country:</b></td> <td>CALIFORNIA</td> </tr> <tr> <td><b>Postal Code:</b></td> <td>95054</td> </tr> </table>		<b>Name:</b>	Intel Corporation	<b>Street Address:</b>	2200 Mission College Boulevard	<b>City:</b>	Santa Clara	<b>State/Country:</b>	CALIFORNIA	<b>Postal Code:</b>	95054		
<b>Name:</b>	Intel Corporation												
<b>Street Address:</b>	2200 Mission College Boulevard												
<b>City:</b>	Santa Clara												
<b>State/Country:</b>	CALIFORNIA												
<b>Postal Code:</b>	95054												
<b>PROPERTY NUMBERS Total: 1</b>													
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>11821864</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	11821864								
Property Type	Number												
Application Number:	11821864												
<b>CORRESPONDENCE DATA</b>													
<p>Fax Number: (713)468-8883</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 512-418-9944</p> <p>Email: tphpto@tphm.com</p> <p>Correspondent Name: Mark J. Rozman</p> <p>Address Line 1: 1616 S. Voss Road, Suite 750</p> <p>Address Line 2: TROP, PRUNER &amp; HU, P.C.</p> <p>Address Line 4: Houston, TEXAS 77057</p>													
<b>ATTORNEY DOCKET NUMBER:</b>	ITL.1636US (P25987)												
<b>NAME OF SUBMITTER:</b>	Mark J. Rozman												

CH \$40.00 11821864

**501061482**

**PATENT**  
**REEL: 023757 FRAME: 0592**

Total Attachments: 3

source=ITL1636USExAssignment#page1.tif

source=ITL1636USExAssignment#page2.tif

source=ITL1636USExAssignment#page3.tif

## **ASSIGNMENT**

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

**ANTHONY YEH CHIING WONG; VICTOR HENCKEL; BOON LIANG HENG;  
CHRISTOPHER WADE ACKERMAN; JAMES C. SHIPLEY**

hereby sell, assign, and transfer to:

### **Intel Corporation**

a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California, 95052 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all foreign countries, in and to any and all inventions and improvements that are disclosed in the application for the United States patent entitled:

### **ACTIVE THERMAL CONTROL USING A BURN-IN SOCKET HEATING ELEMENT**

(I hereby authorize and request my attorney, associated with Customer Number 47795, to insert on the designated lines below, the filing date and application number of said application when known.)

which was filed on 06/26/2007 as

United States Application Number 11/821,864 and

which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below,

and in and to said application and all design, utility, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and all other patent applications that have been or shall be filed in the United States and all foreign countries on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all foreign countries on said inventions and improvements; and in and to all rights of priority resulting from the filing of said United States applications;

agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all design, utility, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and

**Attorney Docket No.: ITL1636US (P25987)**

improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

  
ANTHONY YEH CHING WONG

June 8 2007  
(Today's Date)

  
VICTOR HENCKEL

6/14/07  
(Today's Date)

  
BOON LIANG HENG

6/8/07  
(Today's Date)

CHRISTOPHER WADE ACKERMAN

(Today's Date)

JAMES C. SHIPLEY

(Today's Date)

improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

\_\_\_\_\_  
ANTHONY YEH CHIING WONG

\_\_\_\_\_  
(Today's Date)

\_\_\_\_\_  
VICTOR HENCKEL

\_\_\_\_\_  
(Today's Date)

\_\_\_\_\_  
BOON LIANG HENG

\_\_\_\_\_  
(Today's Date)

  
\_\_\_\_\_  
CHRISTOPHER WADE ACKERMAN

June 7 2007  
\_\_\_\_\_  
(Today's Date)

  
\_\_\_\_\_  
JAMES C. SHIPLEY

6-7-07  
\_\_\_\_\_  
(Today's Date)